



Part Number : 2128252652

Product Description : DDR4 DIMM Socket, Vertical Surface Mount, 0.38µm Gold Plating, 288 Circuits, with 2.00mm Solder Tab, Black Housing, Black Latch, with Pick-and-Place Tape


Series Number : 212825

Status : Active

Product Category : Memory Module Connectors

## Product Environment Compliance

### Compliance

GADSL/IMDS	Not Relevant
China RoHS	
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2024)4144-DC (27 June 2024)
EU RoHS	Compliant per EU 2015/863

### Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen

### Multiple Part Industry Compliance Documents

- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

### EU RoHS Certificate of Compliance

## Part Details

### General

Status	Active
Category	Memory Module Connectors
Series	212825

Description	DDR4 DIMM Socket, Vertical Surface Mount, 0.38µm Gold Plating, 288 Circuits, with 2.00mm Solder Tab, Black Housing, Black Latch, with Pick-and-Place Tape
Component Type	Socket
JEDEC Outline	MO-309
Product Family	DDR4 DIMM Sockets
Product Name	DDR4 DIMM
UPC	193264209248

## Electrical

Current - Maximum per Contact	0.75A
Voltage - Maximum	29V AC (RMS)/DC

## Physical

Circuits (Loaded)	288
Circuits (maximum)	288
Durability (mating cycles max)	25
Entry Angle	Vertical (Top Entry)
Housing Color	Black
Keying to Mating Part	None
Latch Color	Black
Material - Metal	Copper Alloy
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Polyamide
Net Weight	6.151/g
Packaging Type	Tray
PCB Locator	Yes
PCB Retention	Yes
Pitch - Mating Interface	0.85mm
Pitch - Termination Interface	0.85mm
Plating min - Mating	0.380µm
Plating min - Termination	2.540µm
Temperature Range - Operating	-55° to +85°C

Termination Interface Style	Surface Mount
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